No.	LD -D2113804B							
DATE	Nov. 8. 2013							

TECHNICAL LITERATURE

For

TFT-LCD module

# These parts have corresponded with the RoHS directive.

# MODEL No. LQ156D1JX01

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DEVELOPMENT DEPARTMENT I

DISPLAY DEVICE UNIT II

DISPLAY DEVICE BUSINESS DIVISION

SHARP CORPORATION

# RECORDS OF REVISION

## LQ156D1JX01

SPEC No.	DATE	REVISED		SUMMARY	NOTE	
		No.	PAGE			
LD-D2113804A	Aug.28.2013	-	-	-	1st Issue	
LD-D2113804B	Nov.8.2013	Δ1	3	Mass SPEC. TBD → (320)	2nd Issue	
			5	Corresponding connector		
				20525-040T-01 → 20524-040T-01		
			8	Current dissipation(Typ) TBD → (440)		
			8	Current dissipation(Max) TBD → (950)		
			8	Power dissipation(Typ) TBD $\rightarrow$ (1.45)		
			8	Power dissipation(Max) TBD → (3.14)		
			10	Typical current condition		
				16-gray-bar pattern →256-gray-bar pattern		
			10	Maximum current condition		
				Max pattern add.		
				TBD → The pattern below	ļ	
			11	Current dissipation(Typ) TBD → (322)		
			11	Current dissipation Remark		
			(	$VBL=12V(TYP), VBL=(7V)(MAX) \rightarrow VBL=12V$		
			11	$Vmin  (TBD)  \rightarrow  (7.0V)$		
			11	$Vth \qquad (TBD)  \rightarrow  (0.9VBL)$		
		,	11	td max (TBD) $\rightarrow$ (20ms)		
		,	19	Viewing angle range (Min) 70 → 80		
		,	19	Contrast ratio (Typ) (900) → (1000)		
			19	Luminance of White (Min) (TBD) → (280)		
	,					

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### 1. Application

This specification applies to a color TFT-LCD module, LQ156D1JX01.

### 2. Overview

This module is a color active matrix LCD module incorporating Oxide TFT (Thin Film Transistor). It is composed of a color TFT-LCD panel, driver ICs, a control circuit and power supply circuit, and a backlight unit. Graphics and texts can be displayed on a 3840×3×2160 dots panel with 16,777,216 colors by using eDP (Embedded Display Port) Ver1.3 interface and supplying +3.3V DC supply voltage for TFT-LCD panel driving and applying DC supply voltage for LED backlight-driving DC/DC converter.

In this TFT-LCD panel, color filters for excellent color performance and backlights for high brightness are incorporated to realize brighter and clearer pictures, making this model optimum for use in multi-media applications.

Optimum viewings are in all directions.

Backlight-driving LED controller is built in this module.

eDP Transfer rate Specification : 5.4Gbps / 4 lane

3. Mechanical Specifications

Parameter	Specifications	Unit
Display size	39.652 (15.6" ) Diagonal	cm
Active area	345.60(H)×194.40 (V)	mm
D: 10	3840 (H)×2160 (V)	pixel
Pixel format	(1 pixel = R+G+B dots)	
Pixel pitch	0.090 (H) × 0.090 (V)	mm
Pixel configuration	R,G,B vertical stripe	
Display mode	Normally black	
Surface treatment	Glare,Hard coating (3H)	

### Outline dimensions

outine unitensions									
Parameter		Min.	Тур.	Max.	Unit	Remark			
	Width	357.62	358.12	358.62	mm	w/o bracket			
Unit outline dimensions	Height	217.31	218.31	219.31	mm	w/o bracket			
[Note 3-1]	Depth	(2.802)	(3.102)	(3.402)	mm	w/ Fix tape			
Mass		_	(320)	_	g	$\triangle$ 1			

[Note 3-1] Outline dimensions is shown in Fig.2

# 4. Input Terminals

# 4 - 1. Symbol

CN1 (eDP signals, +3.3V DC power supply, and B/L power supply)

Pin No.	Symbol	I/O	Function	Remark
1	NC	-	Reserved for LCD manufacturer's use	[Note4-1-1]
2	H_GND	P	High Speed Ground	
3	Lane3_N	I	Complement Signal Link Lane 3	
4	Lane3_P	I	True Signal Link Lane 3	
5	H_GND	P	High Speed Ground	
6	Lane2_N	I	Complement Signal Link Lane 2	
7	Lane2_P	I	True Signal Link Lane 2	
8	H_GND	P	High Speed Ground	
9	Lane1_N	I	Complement Signal Link Lane 1	
10	Lane1_P	I	True Signal Link Lane 1	
11	H_GND	P	High Speed Ground	
12	Lane0_N	I	Complement Signal Link Lane 0	
13	Lane0_P	I	True Signal Link Lane 0	
14	H_GND	P	High Speed Ground	
15	AUX_CH_P	I	True Signal Auxiliary Channel	
16	AUX_CH_N	I	Complement Signal Auxiliary Channel	
17	H_GND	P	High Speed Ground	
18	VDD	P	LCD logic and driver power(3.3V)	
19	VDD	P	LCD logic and driver power(3.3V)	
20	VDD	P	LCD logic and driver power(3.3V)	
21	VDD	P	LCD logic and driver power(3.3V)	
22	NC		Reserved for LCD manufacturer's use	[Note4-1-1]
23	LCD_GND	P	LCD logic and driver ground	
24	LCD_GND	P	LCD logic and driver ground	
25	LCD_GND	P	LCD logic and driver ground	
26	LCD_GND	P	LCD logic and driver ground	
27	HPD	О	HPD signal pin	
28	BL_GND	P	Backlight ground	
29	BL_GND	P	Backlight ground	
30	BL_GND	P	Backlight ground	
31	BL_GND	P	Backlight ground	
32	BL_ENABLE	I	Backlight On/Off	
33	BL_PWM_DIM	I	System PWM	
34	NC	-	Reserved for LCD manufacturer's use	[Note4-1-1]
35	NC	-	Reserved for LCD manufacturer's use	[Note4-1-1]
36	VBL	P	Backlight power	
37	VBL	P	Backlight power	
38	VBL	P	Backlight power	
39	VBL	P	Backlight power	
40	NC	-	Reserved for LCD manufacturer's use	[Note4-1-1]

[Note 4-1-1] Don't input any signals or any powers into a NC pin. Keep the NC pin open.

[Note 4-1-2] The shielding case is connected with signal GND.

- Connector used: 20525-040E-02 (IPEX)

#### 4 - 2. eDP interface

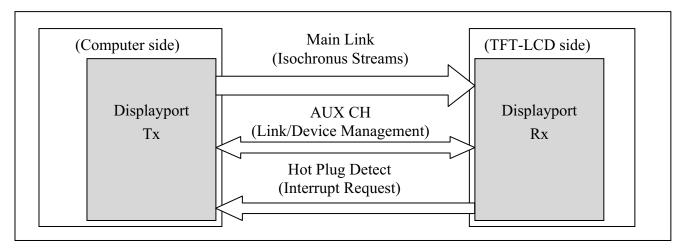


Fig.4-2-1 DP architecture.

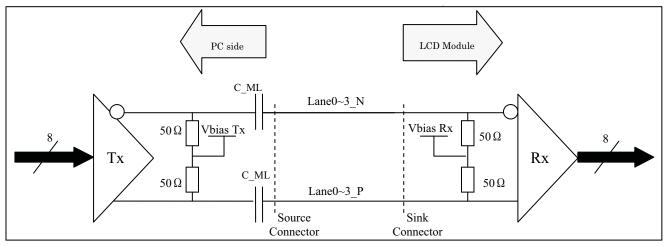


Fig.4-2-2 Main Link differential pair.

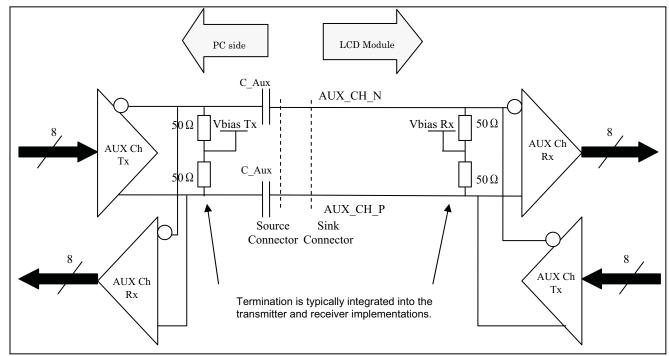


Fig.4-2-3 AUX Link differential pair.

Lane0	Lane1	Lane2	Lane3
R0-7:0	R1-7:0	R2-7:0	R3-7:0
G0-7:0	G1-7:0	G2-7:0	G3-7:0
B0-7:0	B1-7:0	B2-7:0	B3-7:0
R4-7:0	R5-7:0	R6-7:0	R7-7:0
G4-7:0	G5-7:0	G6-7:0	G7-7:0
B4-7:0	B5-7:0	B6-7:0	B7-7:0
R8-7:0	R9-7:0	R10-7:0	R11-7:0
G8-7:0	G9-7:0	G10-7:0	G11-7:0
B8-7:0	B9-7:0	B10-7:0	B11-7:0

Fig.4-2-5 eDP 4 lane 8 bit input data mapping.

### 5. Absolute Maximum Ratings

D	C11	C 4:4:	Rat	ings	T T :4	D 1
Parameter	Symbol	Condition	Min.	Max.	Unit	Remark
+3.3V supply voltage	VDD	Ta=25°C	-0.3	+4.0	V	
Back Light supply voltage	VBL	Ta=25°C	-0.3	+26.5	V	
Input voltage(eDP)	VI	Ta=25°C	-0.3	+1.8	V	[Note 5-1]
Input voltage(BL)	BL_I	Ta=25°C	-0.3	(VDD+0.3)	V	[Note 5-2]
Storage temperature (ambient)	Tstg	_	-20	+60	$^{\circ}\!\mathbb{C}$	[Note 5-4]
Operating temperature(ambient)	Topa	_	0	+50	$^{\circ}\! \mathbb{C}$	

[Note 5-1] eDP signals

[Note 5-2] Back light control signals (BL\_ENABLE, BL\_PWM\_IN)

[Note 5-3] Humidity: 90%RH Max. at  $Ta \le +40^{\circ}C$ .

Maximum wet-bulb temperature at  $+39^{\circ}$ C or less at Ta> $+40^{\circ}$ C.

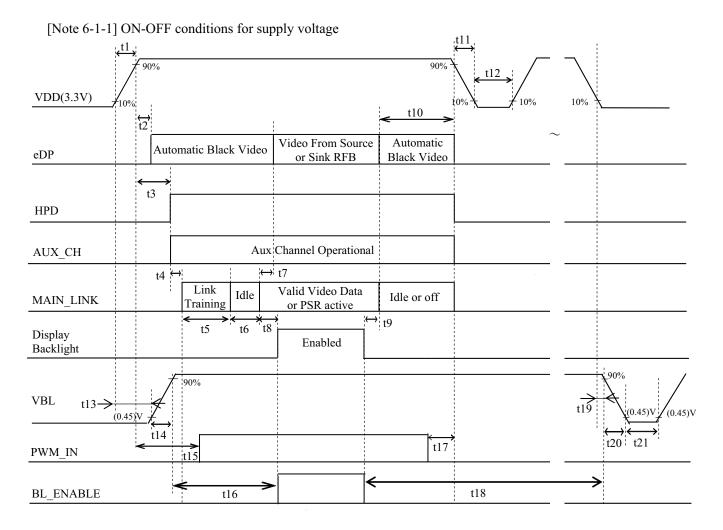
No condensation.

# 6. Electrical Characteristics

# 6 - 1. TFT-LCD panel driving

 $Ta=+25^{\circ}C$ 

										Ta=+25°C
	DC Electri	ical (	Chara	act	eristi	cs				
Parameter	Symbol	Mi	n.	Ту	p.	Max		Unit		Remark
Supply voltage	VDD	+3.	.0	+3.3		+3.6		V	[]	Note 6-1-1]
Current dissipation	IDD -			(44	0)	(950	))	mA	[]	Note 6-1-2] △1
Power dissipation	PDD	_		(1.4	15)	(3.14	4)	W	[]	Note 6-1-2] △1
Permissive input ripple voltage	V <sub>RP</sub>	_		_	-	100		mV <sub>P-P</sub>	V	DD = +3.3V
	eDP AUX C	Chanr	el Ch	ara	cterist	ics		,		
Parameter	Symbol	1	Min		Тур.	M	ax.	Uni	t	Remark
Unit Interval for AUX channel	Ulaux		(0.4	)	(0.5)	(0	0.6)	μs		
peak-to-peak voltage at TP1	V <sub>AUX-DIFF</sub>	p	(0.32	2)	· -	(1.	.36)	V		
AUX DC Common Mode Voltage	Vaux-dc-c	СМ	-		(0.9)		-	V		
AUX Short Circuit Current Limit	laux_shor	₹T	-		-	(9	90)	mA		
AUX CH termination DC resistance	Rauxtef	RM	-		(100)	(100) -		Ω		
AUX AC Coupling Capacitor	Caux		(75)	)	-	- (200)		nF		
Number of pre-charge pulses	Pre-charq pulses		(10)	)	-	(1	16)	-		
eD	P Main Link	Reco	eiver (	Cha	racter	istics				
Parameter	Symbol	1	Min		Тур.	M	ax.	Uni	t	Remark
Link clock down spreading	Down_Spre Amplitude	ead_	0		-	(	0)	%		△1
Differential Peak-to-peak Input Voltage at RX package pins	VRX-DIFFp	)-p	(90)	)	-	(12	200)	mV	,	
Differential Return Loss at 1.35 GHz at RX package pins	RL <sub>RX-DIF</sub>	F	(9)		-		-	dB		
RX DC Common Mode Voltage	V <sub>RX-DC-C</sub>	М	(0)		-	(2	2.0)	V		
Differential termination resistance	Vrx-term		-		(100)	)	-	Ω		
RX Short Circuit Current Limit	Irx-shor	Т	-		-	(5	50)	mA	,	
Lane Intra-pair Skew at RX package pins	LRX-SKEW-INT -PAIR-High-Bit-R		-		-	(5	50)	ps		



[Note] Do not keep the interface signal high-impedance or unusual signal when power is on.

Symbol	Min	Max	Unit	Note
t1	(0.5)	(10)	ms	
t2	(0)	(200)	ms	
t3	0	100	ms	
t4	-	-	ms	
`t5	-	-	ms	
t6	-	-	ms	
t7	0	50	ms	
t8	-	-	ms	
t9	-	-	ms	
t10	0	500	ms	
t11	(1)	(50)	ms	[Note 1]
t12	500	-	ms	
t13	-	-	ms	
t14	(0.1)	(10)	ms	
t15	(100)		ms	
t16	0	-	ms	
t17	0	-	ms	
t18		-		
t19	-	-	ms	
t20	(0.1)	-	ms	
t21	(100)		ms	

[Note 1] As for the power off sequence for VDD (t11), Be sure to keep above mentioned timing.

If the VDD power off sequence timing is other than shown above, LCD may cause permanent damage.

As for the power sequence for backlight, it is recommended to apply above mentioned input timing.

If the backlight is light on and off at a timing other than shown above, displaying image may get disturbed.

### VDD-dip conditions

1) 2.5 V≦VDD<3.0 V

 $td \leq 10 \text{ ms}$ 

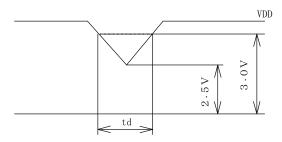
Under above condition, the display image should return to an appropriate figure after VDD voltage recovers.

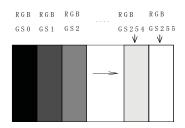
2) VDD < 2.5 V

VDD-dip conditions should also follow the ON-OFF conditions for supply voltage

[Note 6-1-2] Typical current condition: 256-gray-bar pattern. VDD=+3.3V

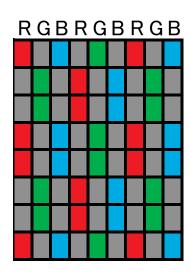
 $\triangle 1$ 





Maximum current condition: The pattern below. VDD=+3.3V

 $\triangle 1$ 



### 6 - 2. Backlight driving

The backlight system is an edge-lighting type with white-LED.

(It is usually required to measure under the following condition. :  $Ta=25^{\circ}C \pm 2^{\circ}C$ )

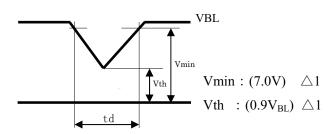
Parameter	Symbol	Min.	Тур.	Max	Unit	Remark
Supply voltage	VBL	(7.0)	12.0	(21.0)	V	
Current dissipation $\triangle 1$	$I_{BL}$	_	(322)	(TBD)	mA	VBL = 12.0V △1 Duty Ratio=100%
Madulated light signal cultures	VPWMH	0.6VDD	3.3	3.6	V	
Modulated light signal voltage	VPWML	0	_	0.7	V	
Brightness Control Duty Ratio	Duty	(1)	_	100	%	[Note6-2-1]
Brightness Control pulse width	$T_{PWM}$	(30)	_		us	[Note6-2-2]
Brightness Control frequency	$f_{PWM}$	(150)	200	(2000)	Hz	
LED-BL ON/OFF High voltage	VCNTH	1.8	3.3	3.6	V	[Note6-2-3]
LED-BL ON/OFF Low voltage	VCNTL	_		0.6	V	[Note6-2-3]
Input signal pin current	I <sub>IN</sub>	_	_	(1.0)	μΑ	BL_ENABLE, BL_PWM_DIM
LED lifetime	-	_	(10,000)	_	h	LED

[Note6-2-1] PWM IN Input: 100%= Max luminance 1%= Min luminance

[Note6-2-2] The minimum value of the dimming signal pulse width is assumed regulations of the width of high and the width of low.

[Note6-2-3] BL\_ENABLE Input : High = BL turn on, Low or OPEN =BL turn off

### VBL-dip conditions



1)  $Vth \leq V_{BL} < Vmin : td \leq (20ms) \triangle 1$ 

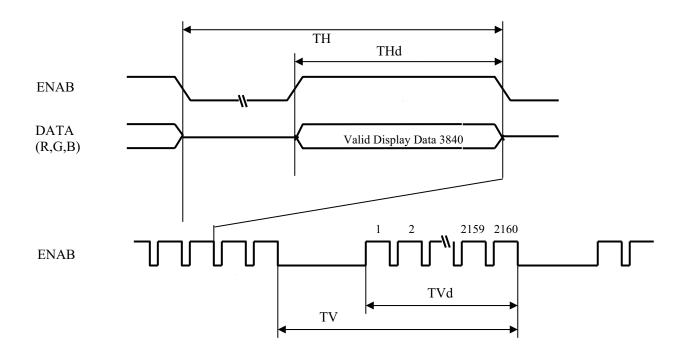
2)  $V_{BL}$  < Vth : The condition of instantaneous voltage drop is apply to input voltage sequences

## 7. Timing Characteristics of Input Signals

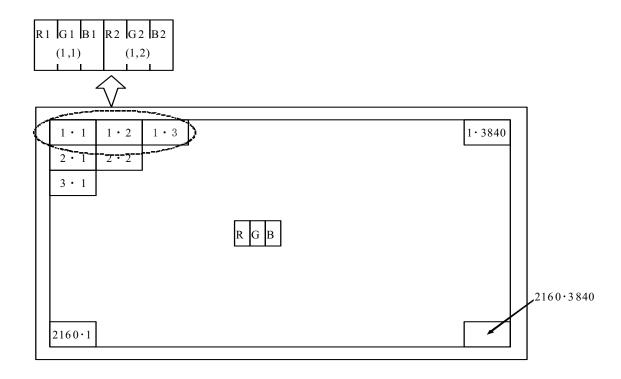
# 7 - 1. Timing characteristics

	Symbol	Min.	Тур.	Max.	Unit	Remark	
Clock	Frequency	1/Tc		(533.25)		MHz	[Note 7-1-1]
	TT	TO 1.1	_	(4000)		clock	
	Horizontal period	TH		(7.501)		μs	
Data enable	Horizontal period (High)	THd	_	3840	_	clock	
Signal			_	(2222)	_	Line	
	Vertical period	TV	_	(16.67)	_	ms	
	Vertical period (High)	TVd		2160	-	line	

[Note 7-1-1] In case of using the long vertical period, the deterioration of display quality, flicker, etc, may occur.



# 7 - 2. Input data signals and display position on the screen



Display position of input data(V  $\cdot$  H)

0 : Low level voltage, 1 : High level voltage

 Each basic color can be displayed in 256 gray scales from 8 bit data signals.

Û

Brighter

Blue

GS253

GS254

GS255

According to the combination of 24 bit data signals, the 16.7M color display can be achieved on the screen.

# 9. EDID Specifications

# 9 - 1. EDID data structure

This is the EDID(Extended Display Identification Data) data formats to support displays as defined in the VESA Plug & Display

Byte	Byte	ided Display Identification Data) data formats to support displays as defined in Field Name and Comments		Value
(decimal)	(hex)		(hex)	(binary)
0	00			
1	01			
2	02			
3	03			
4	04			
5	05			
6	06			
7	07			
8	08			
9	09			
10	0A			
11	0B			
12	0C			
13	0D			
14	0E			
15	0F			
16	10	T.B.D		
17	11			
18	12			
19	13			
20	14			
21	15			
22	16			
23	17			
24	18			
25	19			
26	1A			
27	1B			
28	1C			
29	1D			
30	1E			

31	1F	
32	20	
33	21	
34	22	
35	23	
36	24	
37	25	
38	26	
39	27	
40	28	
41	29	
42	2A	
43	2B	
44	2C	
45	2D	
46	2E	
47	2F	
48	30	T.B.D
49	31	1.D.D
50	32	
51	33	
52	34	
53	35	
54	36	
55	37	
56	38	
57	39	
58	3A	
59	3B	
60	3C	
61	3D	
62	3E	
63	3F	
64	40	
65	41	
		-
66	42	

	<u> </u>
67	43
68	44
69	45
70	46
71	47
72	48
73	49
74	4A
75	4B
76	4C
77	4D
78	4E
79	4F
80	50
81	51
82	52
83	53
84	54
85	55
86	56
87	57
88	58
89	59
90	5A
91	5B
92	5C
93	5D
94	5E
95	5F
96	60
97	61

98	62
99	63
100	64
_	
101	65
102	66
103	67 68
104	69
106	6A
107	6B
108	6C
109	6D
110	6E
111	6F
112	70
113	71
114	72
115	73
116	74
117	75
118	76
119	77
120	78
121	79
122	7A
123	7B
124	7C
	7D
125	עז
126	7E
127	7F

### 10. Optical Characteristics

Ta=+25°C, VDD=+3.3V

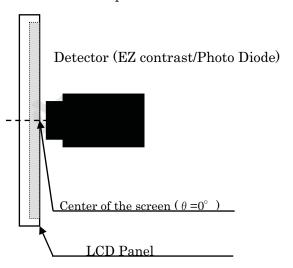
Parameter		Symbol	Condition	Min.	Тур.	Max.	Unit	Remark
Viewing	Horizontal	$\theta$ 21, $\theta$ 22		80	88	_	deg.	DI . 10 1 10 2 10 4
angle range	X7 4: 1	θ 11	CR>10	80	88	_	deg.	[Note 10-1, 10-3, 10-4,
$\triangle 1$	Vertical	θ 12		80	88	_	deg	10-6]
Contrast ratio △1		CR	$\theta$ =0°	(700)	(1000)	_		[Note 10-1, 10-4, 10-6]
Response ti	me	τ r+ τ d		_	25	_	ms	[Note 10-2, 10-5, 10-6]
Chromaticity	of white	X		(0.283)	(0.313)	(0.343)		
		y		(0.299)	(0.329)	(0.359)		
Chromaticity of red		X		_	(0.640)	_		
·		y		_	(0.330)	_		
Chromaticity	of green	X	$\theta=0^{\circ}$	_	(0.300)	_		[Note 10-2, 10-6]
		y		_	(0.600)	_ 1		Normal operation (PWM Duty=100%)
Chromaticity of blue		X		_	(0.150)			(1 WW Buty 10070)
,		y		_	(0.060)	_		
NTSC ratio				(68)	(72)		%	
Luminance of white △1		$Y_{\text{LI}}$		(280)	(330)	_	cd/m <sup>2</sup>	
White Uniformity		δw	$\theta = 0^{\circ}$	_	(1.25)	(1.40)		[Note 10-2, 10-7]

<sup>\*</sup> The measurement shall be taken (30) minutes after lighting the module at the following rating:

Condition: PWM Duty = 100%

The optical characteristics shall be measured in a dark room or equivalent.

[Note 10-1] Measurement of viewing angle range and Response time.



Viewing angle range:EZ-CONTRAST

Field=2°

Center of the screen ( $\theta = 0^{\circ}$ )

LCD Panel

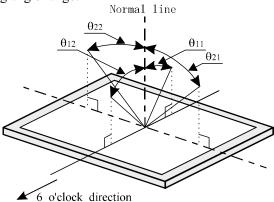
[Note 10-2] Measurement of luminance and

Chromaticity and Contrast.

Detector(SR-3)

/Response time: Photo diode)

[Note 10-3] Definitions of viewing angle range:

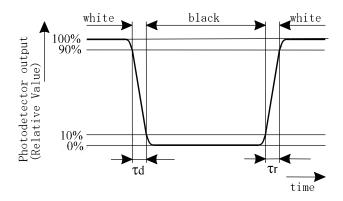


### [Note 10-4] Definition of contrast ratio:

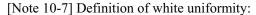
The contrast ratio is defined as the following.

### [Note 10-5] Definition of response time:

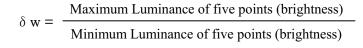
The response time is defined as the following figure and shall be measured by switching the input signal for "black" and "white" .

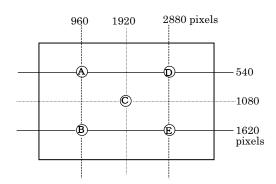


[Note 10-6] This shall be measured at center of the screen.



White uniformity is defined as the following with five measurements  $(A \sim E)$ .





### 11. Display Quality

The display quality of the color TFT-LCD module shall be in compliance with the Incoming Inspection Standard.

- 12. Handling Precautions
  - a) Be sure to turn off the power supply when inserting or disconnecting the cable.
    - Please insert for too much stress not to join a connector in the case of insertion of a connector.
  - b) Be sure to design the cabinet so that the module can be installed without any extra stress such as warp or twist.
  - c) Since the front polarizer is easily damaged, pay attention not to scratch it.
  - d) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
  - e) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
  - f) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface. Handle with care.
  - g) Since CMOS LSI is used in this module, take care of static electricity and injure the human earth when handling. Observe all other precautionary requirements in handling components.
  - h) This module has its circuitry PCBs on the side and should be handled carefully in order not to be stressed.
  - i) Protect sheet(Laminate film) is attached to the module surface to prevent it from being scratched. Peel the sheet off slowly just before the use with strict attention to electrostatic charges. Ionized air shall be blown over during the action. Blow off the 'dust' on the polarizer by using an ionized nitrogen gun, etc. Working under the following environments is desirable.
    - All workers wear conductive shoes, conductive clothes, conductive fingerstalls and grounding belts without fail.
    - Use Ionized blower for electrostatic removal, and peel of the protect sheet with a constant speed. (Peeling of it at over 2 seconds)
  - j) The polarizer surface on the panel is treated with Anti Glare. In case of attaching protective board over the LCD, be careful about the optical interface fringe etc. which degrades display quality.
  - k) Do not expose the LCD module to a direct sunlight, for a long period of time to protect the module from the ultra violet ray.
  - When handling LCD modules and assembling them into cabinets, please be noted that long-term storage in the environment of oxidization or deoxidization gas and the use of such materials as reagent, solvent, adhesive, resin, etc. which generate these gasses, may cause corrosion and discoloration of the LCD modules.
  - m) Liquid crystal contained in the panel may leak if the LCD is broken. Rinse it as soon as possible if it gets inside your eye or mouth by mistake.
  - n) Disassembling the module can cause permanent damage and should be strictly avoided.

    Please don't remove the fixed tape, insulating tape etc that was pasted on the original module.

(Except for protection film of the panel.)

- o) Be careful when using it for long time with fixed pattern display as it may cause afterimage. (Please use a screen saver etc., in order to avoid an afterimage.)
- p) If a minute particle enters in the module and adheres to an optical material, it may cause display non-uniformity issue, etc. Therefore, fine-pitch filters have to be installed to cooling and inhalation hole if you intend to install a fan.
- q) Epoxy resin (amine series curing agent), silicone adhesive material (dealcoholization series and oxime series),
  - tray forming agent (azo compound) etc, in the cabinet or the packing materials may induce abnormal display with polarizer film deterioration regardless of contact or noncontact to polarizer film.

    Be sure to confirm the component of them.
- r) Do not use polychloroprene. If you use it, there is some possibility of generating Cl<sub>2</sub> gas that influences the reliability of the connection between LCD panel and driver IC.

- t) Do not put a laminate film on LCD module, after peeling of the original one. If you put on it, it may cause discoloration or spots because of the occurrence of air gaps between the polarizer and the film.
- u) Ground module bezel to stabilize against EMI and external noise.

13. Packaging Condition

Piling number of cartons	T.B.D.
Package quantity in one carton	T.B.D.
Carton size	T.B.D.
Total mass of one carton filled with full modules	T.B.D.
Packing form	Fig.1

14. Label		
1) Module ba	rcode label:	
T.B.D		
2) Packing	bar code label	
T.B.D		
11212		

This LCD module is compliant with RoHS Directive.

15. RoHS Directive

16. Reliability Test Items

	tenaonity rest items	
No.	Test item	Conditions
1	High temperature storage test	$Ta = 60^{\circ}C$ 240h
2	Low temperature storage test	Ta = -20°C 240h
3	High temperature	$Ta = 40^{\circ}C ; 90^{\circ}RH 240h$
	& high humidity operation test	(No condensation)
4	High temperature operation test	$Ta = 50^{\circ}C$ 240h
5	Low temperature operation test	$Ta = 0^{\circ}C \qquad 240h$
6	Vibration test	T.B.D
	(non- operating)	
7	Shock test	
	(non- operating)	
8	ESD	

[Result Evaluation Criteria] Under the display quality test conditions with normal operation state. Do not change these conditions as such changes may affect practical display function.

[Normal operation state] Temperature : +15~+35°C, Humidity : 45~75%, Atmospheric pressure : 86  $\sim\!106\mathrm{kPa}$ 

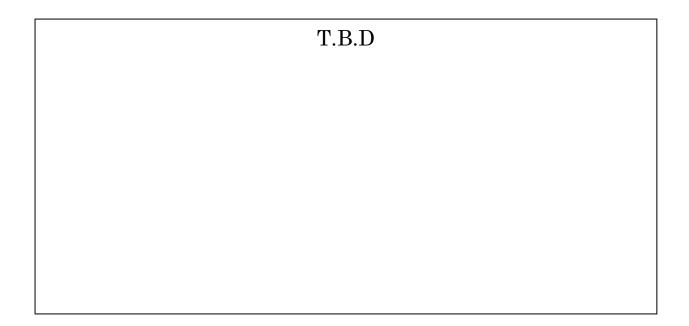


Fig. 1 Packaging Condition

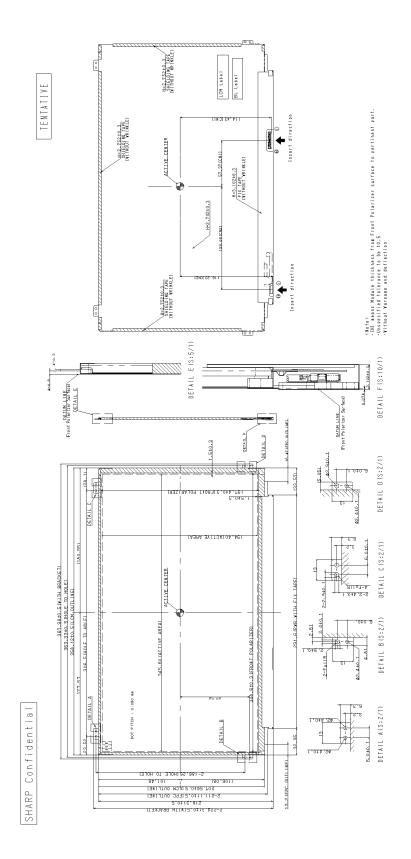


Fig. 2 Outline Dimension